

# **Complementary Silicon Plastic Power Transistors**

... designed for use in general purpose amplifier and switching applications.

• Collector – Emitter Saturation Voltage —

 $V_{CE(sat)} = 1.5 \text{ Vdc (Max)} @ I_C = 6.0 \text{ Adc}$ 

• Collector Emitter Sustaining Voltage —

V<sub>CEO(sus)</sub> = 80 Vdc (Min) — BD243B, BD244B = 100 Vdc (Min) — BD243C, BD244C

• High Current Gain Bandwidth Product

 $f_T = 3.0 \text{ MHz (Min)} @ I_C = 500 \text{ mAdc}$ 

• Compact TO-220 AB Package

#### **MAXIMUM RATINGS**

Rating	Symbol	BD243B BD244B	BD243C BD244C	Unit
Collector–Emitter Voltage	VCEO	80	100	Vdc
Collector-Base Voltage	VCB	80	100	Vdc
Emitter-Base Voltage	V <sub>EB</sub> 5.0 Vdc		5.0	
Collector Current — Continuous Peak	IC	6 10		Adc
Base Current	ΙΒ	2.0		Adc
Total Device Dissipation  @ T <sub>C</sub> = 25°C  Derate above 25°C	PD	65 0.52		Watts W/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150		°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.92	°C/W

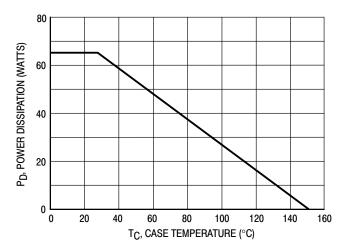
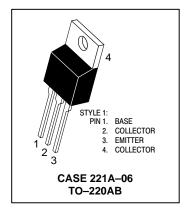


Figure 1. Power Derating

BD243B
BD243C\*
BD244B
BD244C\*

\*ON Semiconductor Preferred Device

6 AMPERE
POWER TRANSISTORS
COMPLEMENTARY
SILICON
80-100 VOLTS
65 WATTS

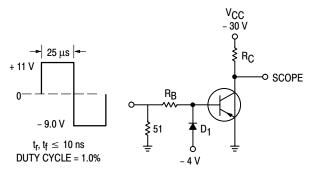


# **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Characte	eristic	Symbol	Min	Max	Unit
Collector–Emitter Sustaining Voltage (1) (I <sub>C</sub> = 30 mAdc, I <sub>B</sub> = 0)	BD243B, BD244B BD243C, BD244C	VCEO(sus)	80 100	_	Vdc
Collector Cutoff Current (V <sub>CE</sub> = 60 Vdc, I <sub>B</sub> = 0)	BD243B, BD243C, BD244B, BD244C	ICEO	_	0.7	mAdc
Collector Cutoff Current (VCE = 80 Vdc, VEB = 0) (VCE = 100 Vdc, VEB = 0)	BD243B, BD244B BD243C, BD244C	ICES	_ _	400 400	μAdc
Emitter Cutoff Current (V <sub>BE</sub> = 5.0 Vdc, I <sub>C</sub> = 0)		IEBO	_	1.0	mAdc
ON CHARACTERISTICS (1)					
DC Current Gain (I <sub>C</sub> = 0.3 Adc, $V_{CE}$ = 4.0 Vdc) (I <sub>C</sub> = 3.0 Adc, $V_{CE}$ = 4.0 Vdc)		hFE	30 15	_	_
Collector–Emitter Saturation Voltage (I <sub>C</sub> = 6.0 Adc, I <sub>B</sub> = 1.0 Adc)		VCE(sat)	_	1.5	Vdc
Base–Emitter On Voltage (IC = 6.0 Adc, VCE = 4.0 Vdc)		V <sub>BE(on)</sub>	_	2.0	Vdc
DYNAMIC CHARACTERISTICS					
Current Cain Pandwidth Braduat (2)		f	2.0		MUZ

Current–Gain — Bandwidth Product (2) (I <sub>C</sub> = 500 mAdc, V <sub>CE</sub> = 10 Vdc, f <sub>test</sub> = 1.0 MHz)	fΤ	3.0	ı	MHz
Small–Signal Current Gain (I <sub>C</sub> = 0.5 Adc, V <sub>CE</sub> = 10 Vdc, f = 1.0 kHz)	h <sub>fe</sub>	20	_	_

<sup>(1)</sup> Pulse Test: Pulsewidth  $\leq$  300  $\mu s,$  Duty Cycle  $\leq$  2.0%.



 ${\rm R}_{\rm B}$  and  ${\rm R}_{\rm C}$  varied to obtain desired current levels D<sub>1</sub> MUST BE FAST RECOVERY TYPE eg. 1N5825 USED ABOVE IB  $\approx 100 \text{ mA}$ MSD6100 USED BELOW IB  $\approx 100 \text{ mA}$ 

Figure 2. Switching Time Test Circuit

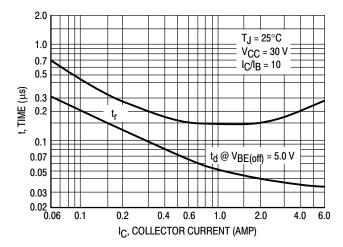


Figure 3. Turn-On Time

<sup>(2)</sup>  $f_T = h_{fe} \cdot f_{test}$ 

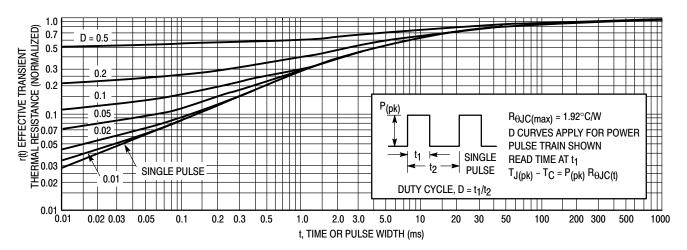


Figure 4. Thermal Response

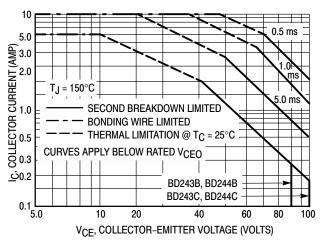


Figure 5. Active Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation, i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on  $T_{J(pk)} = 150^{\circ}C$ :  $T_{C}$  is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided  $T_{J(pk)} \le 150^{\circ}C$ ,  $T_{J(pk)}$  may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

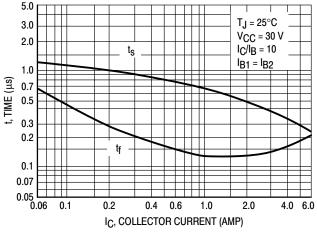


Figure 6. Turn-Off Time

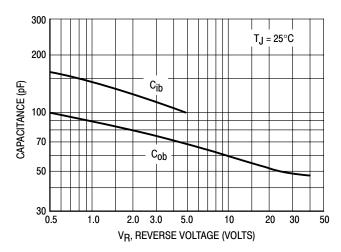


Figure 7. Capacitance

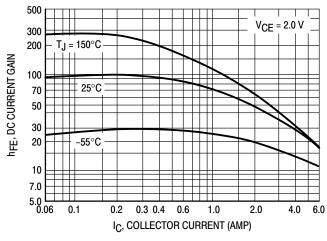


Figure 8. DC Current Gain

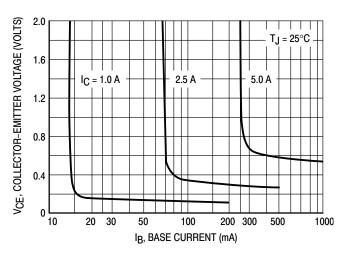


Figure 9. Collector Saturation Region

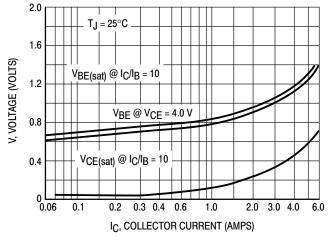
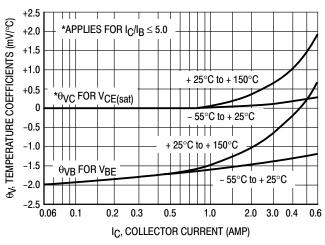


Figure 10. "On" Voltages



**Figure 11. Temperature Coefficients** 

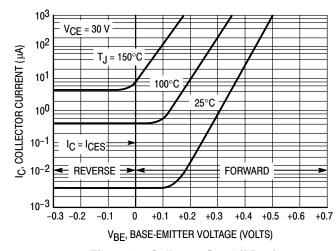


Figure 12. Collector Cut-Off Region

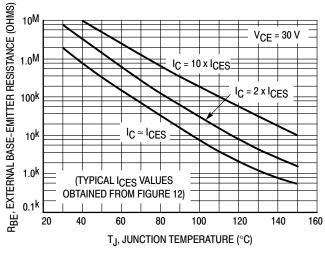
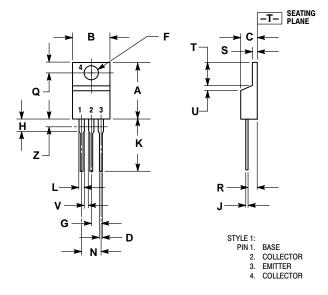


Figure 13. Effects of Base-Emitter Resistance

# **PACKAGE DIMENSIONS**

# TO-220 **CASE 221A-09 ISSUE AA**



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INC	INCHES MILLIMETERS		
DIM	MIN	MAX	MIN MAX	
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04





ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer.

#### PUBLICATION ORDERING INFORMATION

### Literature Fulfillment:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA

**Phone**: 303–675–2175 or 800–344–3860 Toll Free USA/Canada **Fax**: 303–675–2176 or 800–344–3867 Toll Free USA/Canada

Email: ONlit@hibbertco.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

**JAPAN**: ON Semiconductor, Japan Customer Focus Center 4–32–1 Nishi–Gotanda, Shinagawa–ku, Tokyo, Japan 141–0031

Phone: 81–3–5740–2700 Email: r14525@onsemi.com

ON Semiconductor Website: http://onsemi.com

For additional information, please contact your local

Sales Representative.